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60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor Rev. 04 — 11 December 2009 F

Product data sheet

Product profile 1.

1.1 General description

NPN/NPN low V_{CEsat} Breakthrough In Small Signal (BISS) transistor pair in a SOT457 (SC-74) Surface Mounted Device (SMD) plastic package.

PNP/PNP complement: PBSS5160DS.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- Dual low power switches (e.g. motors, fans)
- Automotive applications

1.4 Quick reference data

Table 1. **Quick reference data**

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|---|--|--------------|-----|-----|------|
| Per trans | istor | | | | | |
| V _{CEO} | collector-emitter voltage | open base | - | - | 60 | V |
| I _C | collector current | | <u>[1]</u> _ | - | 1 | А |
| I _{CM} | peak collector current | single pulse; $t_p \leq 1 \text{ ms}$ | - | - | 2 | А |
| R _{CEsat} | collector-emitter saturation resistance | I _C = 1 A; I _B = 100 mA | [2] _ | 200 | 250 | mΩ |

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.



60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

2. Pinning information

| Table 2. | Pinning | | |
|----------|---------------|--------------------|--------|
| Pin | Description | Simplified outline | Symbol |
| 1 | emitter TR1 | | |
| 2 | base TR1 | | |
| 3 | collector TR2 | 0 | |
| 4 | emitter TR2 | | |
| 5 | base TR2 | | |
| 6 | collector TR1 | | 1 2 3 |
| | | | sym020 |

3. Ordering information

| Table 3. Ordering information | | | | |
|-------------------------------|---------|--|---------|--|
| Type number | Package | | | |
| | Name | Description | Version | |
| PBSS4160DS | SC-74 | plastic surface mounted package (TSOP6); 6 leads | SOT457 | |

4. Marking

| Table 4. Marking codes | |
|------------------------|--------------|
| Type number | Marking code |
| PBSS4160DS | B8 |

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|--------------------------------------|--------------|------|------|
| Per trans | sistor | | | | |
| V _{CBO} | collector-base voltage | open emitter | - | 80 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 60 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I _C | collector current | | <u>[1]</u> _ | 0.87 | А |
| | | | [2] _ | 1 | А |
| | | | [3] _ | 1 | А |
| I _{CM} | peak collector current | single pulse; $t_p \le 1 \text{ ms}$ | - | 2 | А |
| I _B | base current | | - | 300 | mA |
| I _{BM} | peak base current | single pulse; $t_p \le 1 \text{ ms}$ | - | 1 | А |

60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

Table 5. Limiting values ...continued

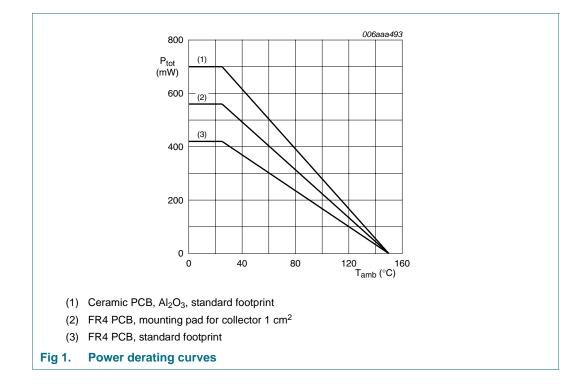
In accordance with the Absolute Maximum Rating System (IEC 60134).

| | | 0 7 (| , | | |
|------------------|-------------------------|------------------------------|--------------|------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | <u>[1]</u> - | 290 | mW |
| | | | [2] _ | 370 | mW |
| | | | <u>[3]</u> _ | 450 | mW |
| Per devi | се | | | | |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | <u>[1]</u> - | 420 | mW |
| | | | [2] _ | 560 | mW |
| | | | <u>[3]</u> _ | 700 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| | | | | | |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.



60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

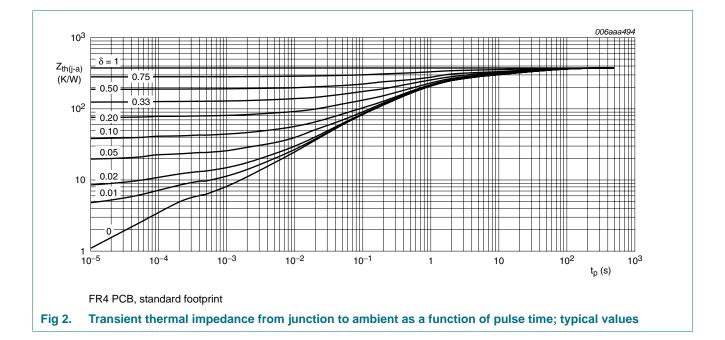
6. Thermal characteristics

| Parameter | Conditions | М | in Ty | p Max | Unit |
|--|---|--|--|--|---|
| stor | | | | | |
| thermal resistance from | in free air | <u>[1]</u> - | - | 431 | K/W |
| junction to ambient | | [2] _ | - | 338 | K/W |
| | | [3] _ | - | 278 | K/W |
| thermal resistance from junction to solder point | | - | - | 105 | K/W |
| 9 | | | | | |
| thermal resistance from | in free air | <u>[1]</u> - | - | 298 | K/W |
| junction to ambient | | [2] _ | - | 223 | K/W |
| | | [3] _ | - | 179 | K/W |
| | stor thermal resistance from junction to ambient thermal resistance from junction to solder point e thermal resistance from | stor in free air inction to ambient in free air thermal resistance from junction to solder point in free air thermal resistance from in free air in free air | stor in free air [1] - junction to ambient [2] - [3] - thermal resistance from - junction to solder point - thermal resistance from in free air [1] - iunction to solder point - - iunction to ambient in free air - iunction to ambient in free air [1] - | stor in free air [1] junction to ambient [2] - [3] - thermal resistance from - - junction to solder point - - thermal resistance from - - junction to solder point - - in free air [1] - junction to ambient in free air [1] | thermal resistance from in free air $\begin{bmatrix} 11 & - & - & 431 \\ 2 & - & - & 338 \\ \hline 3 & - & - & 278 \\ \hline 105 \\ \hline 2 & - & - & 105 \\ \hline 105 \\ \hline$ |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

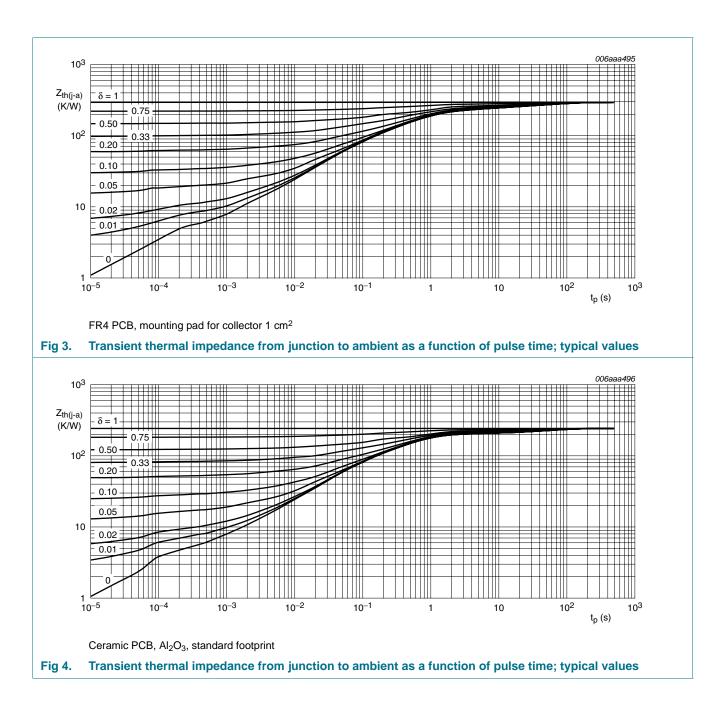
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.



PBSS4160DS

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60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

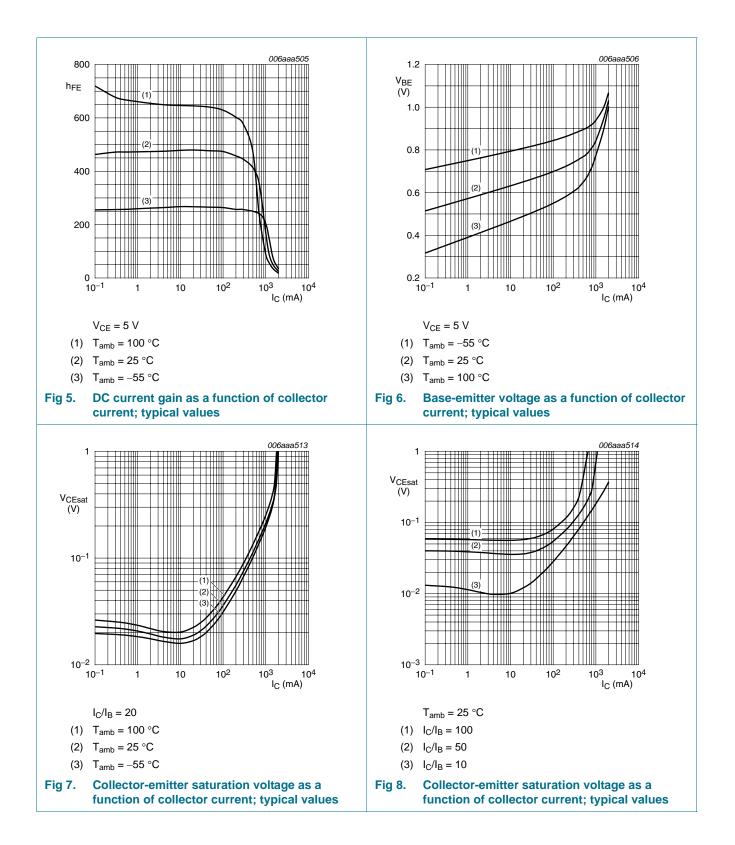
7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|---|---|-----------------|------|-----|------|
| Per trans | istor | | | | | |
| I _{CBO} | collector-base cut-off | $V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}$ | - | - | 100 | nA |
| | current | $V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$ | - | - | 50 | μA |
| I _{CES} | collector-emitter cut-off current | $V_{CE} = 60 \text{ V}; V_{BE} = 0 \text{ V}$ | - | - | 100 | nA |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$ | - | - | 100 | nA |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$ | 250 | 500 | - | |
| | | $V_{CE} = 5 \text{ V}; I_{C} = 500 \text{ mA}$ | <u>[1]</u> 200 | 420 | - | |
| | | $V_{CE} = 5 \text{ V}; \text{ I}_{C} = 1 \text{ A}$ | [<u>1]</u> 100 | 180 | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = 100 \text{ mA}; I_{B} = 1 \text{ mA}$ | - | 90 | 110 | mV |
| | | $I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}$ | - | 115 | 140 | mV |
| | | $I_{C} = 1 \text{ A}; I_{B} = 100 \text{ mA}$ | <u>[1]</u> _ | 200 | 250 | mV |
| R _{CEsat} | collector-emitter saturation resistance | I _C = 1 A; I _B = 100 mA | <u>[1]</u> | 200 | 250 | mΩ |
| V _{BEsat} | base-emitter saturation voltage | I _C = 1 A; I _B = 50 mA | [1] - | 0.95 | 1.1 | V |
| V _{BEon} | base-emitter turn-on voltage | $V_{CE} = 5 V; I_C = 1 A$ | <u>[1]</u> - | 0.82 | 0.9 | V |
| t _d | delay time | $I_{C} = 0.5 \text{ A}; I_{Bon} = 25 \text{ mA};$ | - | 11 | - | ns |
| t _r | rise time | $I_{Boff} = -25 \text{ mA}$ | - | 78 | - | ns |
| t _{on} | turn-on time | | - | 90 | - | ns |
| t _s | storage time | | - | 340 | - | ns |
| t _f | fall time | | - | 160 | - | ns |
| t _{off} | turn-off time | | - | 500 | - | ns |
| f _T | transition frequency | V_{CE} = 10 V; I_C = 50 mA; f = 100 MHz | 150 | 220 | - | MHz |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz | - | 5.5 | 10 | pF |

 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu \mbox{s; } \delta \leq 0.02. \end{tabular}$

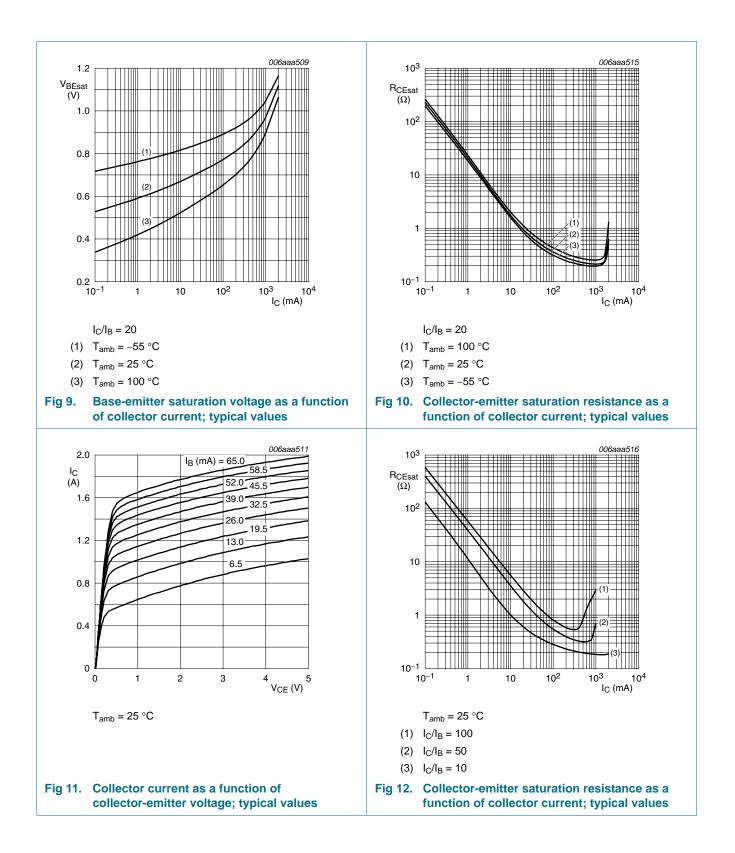
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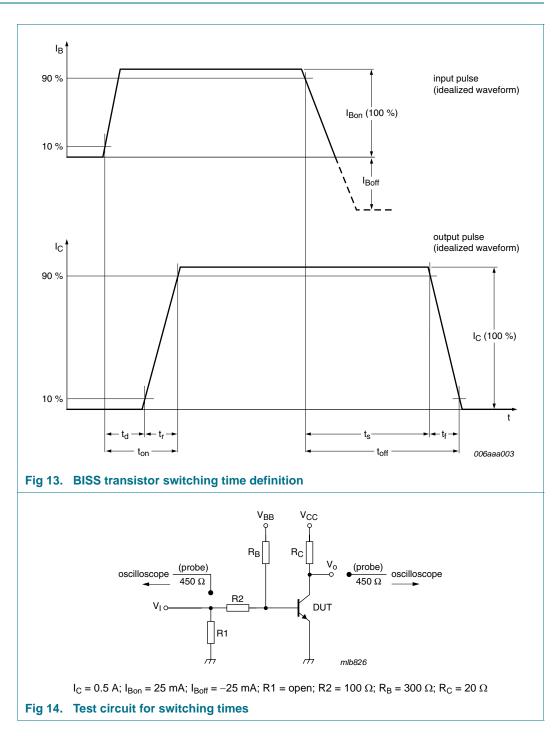
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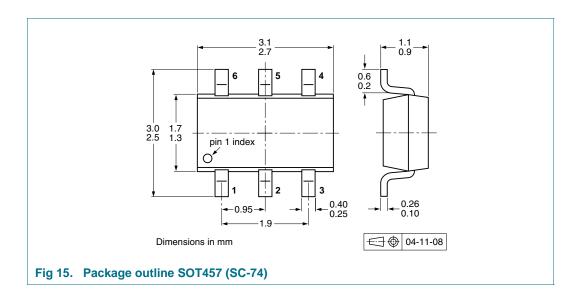
60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

8. Test information



60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing | g quantity |
|-------------|---------|------------------------------------|---------------------|------------|
| | | | 3000 | 10000 |
| PBSS4160DS | SOT457 | 4 mm pitch, 8 mm tape and reel; T1 | ^[2] -115 | -135 |
| | | 4 mm pitch, 8 mm tape and reel; T2 | <u>[3]</u> -125 | -165 |

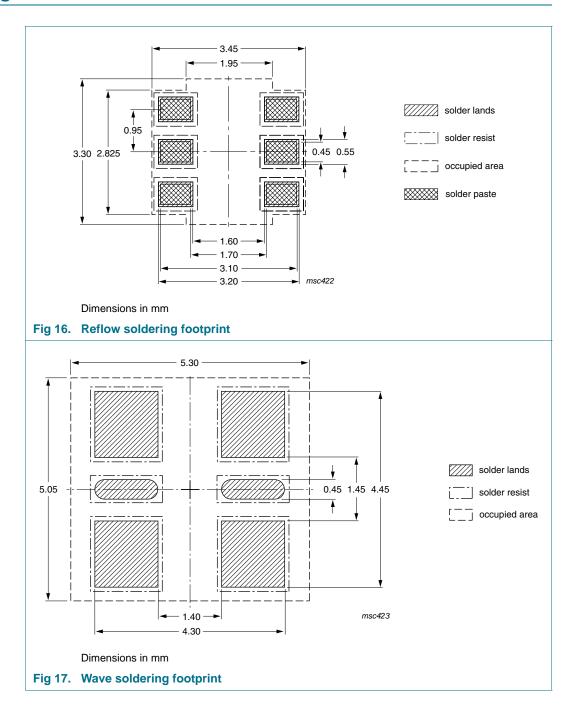
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

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11. Soldering



60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

12. Revision history

| Table 9. Revision | history | | | |
|-------------------|--------------------------|---|----------------------|--------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PBSS4160DS_4 | 20091211 | Product data sheet | - | PBSS4160DS_3 |
| Modifications: | including ne content. | eet was changed to reflect to w legal definitions and discl vave soldering footprint": up | aimers. No changes w | |
| PBSS4160DS_3 | 20060209 | Product data sheet | - | PBSS4160DS_2 |
| PBSS4160DS_2 | 20050627 | Product data sheet | - | PBSS4160DS_1 |
| PBSS4160DS_1 | 20040426 | Objective data sheet | - | - |
| | | | | |

60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

13. Legal information

Data sheet status 13.1

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://w

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60 V, 1 A NPN/NPN low V_{CEsat} (BISS) transistor

15. Contents

| 1 | Product profile 1 |
|------|---------------------------|
| 1.1 | General description 1 |
| 1.2 | Features |
| 1.3 | Applications 1 |
| 1.4 | Quick reference data 1 |
| 2 | Pinning information 2 |
| 3 | Ordering information 2 |
| 4 | Marking 2 |
| 5 | Limiting values 2 |
| 6 | Thermal characteristics 4 |
| 7 | Characteristics 6 |
| 8 | Test information 9 |
| 9 | Package outline 10 |
| 10 | Packing information 10 |
| 11 | Soldering 11 |
| 12 | Revision history 12 |
| 13 | Legal information 13 |
| 13.1 | Data sheet status 13 |
| 13.2 | Definitions 13 |
| 13.3 | Disclaimers |
| 13.4 | Trademarks 13 |
| 14 | Contact information 13 |
| 15 | Contents 14 |

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